APPLICA	BLE STAN	DARD						
	OPERATING		= -35°C TO + 85°C(NOTE1) STOP		RAGE	-10°C TO + 60°	· · ·	
RATING	TEMPERATURE RANGE OPERATING				PERATURE RANGE	-10°C 10 + 60°		
	HUMIDITY RANGE		40 % TO 80 % (NOTE2)		MIDITY RANGE	40 % TO 70 % (NOTE		
	VOLTAGE		0007.40		PLICABLE INECTOR	DF1-*S-2.5C(#)		
	OUDDENT		AWG 24 : 3 A		PLICABLE	DF1-2428SC(F)		
	CURRENT		AWG 26 : 2 A	CO	NTACT			
			AWG 28 : 1 A					
			SPECIFIC <i>A</i>	NTIO	NS			
ITEM		TEST METHOD			REQUIREMENTS			АТ
CONSTR	UCTION				•			
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.			Х
MARKING		CONFIRMED VISUALLY.]	Χ	Х	
	C CHARA							
CONTACT RESISTANCE		100 mA(DC OR 1000HZ).			30 mΩ MAX.			_
INSULATION		500 V DC.			1000 MΩ MIN.			-
RESISTANCE					NO FLASHOVER OR BREAKDOWN.			
VOLTAGE PROOF		650 V AC FOR 1 min.			NO FLASHOVER C	Χ	_	
	IICAL CHA						Х	
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.			 ① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			① NO ELECTRICAL DISCONTINUITY OF 1 μs.			-
sноск		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			-
ENVIRON	MENTAL	CHARA	ACTERISTICS		l			
RAPID CHANGE OF TEMPERATURE		TEMPERATURE $-55 \rightarrow 5$ TO $35 \rightarrow +85 \rightarrow 5$ TO 35° C TIME $30 \rightarrow 10$ TO 15min UNDER 5 CYCLES.			 CONTACT RESISTANCE: 30 mΩ MAX. INSULATION RESISTANCE: 1000 MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 			_
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.						_
RESISTANCE TO SOLDERING HEAT		SOLDER TEMPERATURE, 260±5 °C, FOR. IMMERSION, DURATION, 10s.		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.			_	
		SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR INSERTION DURATION, 5s.			SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.			_
REMARKS NOTE1 : INCL	UDING THE TEN	MPERATUR	RE RISE BY CURRENT.		•			

NOTE2 : NON-CONDENSING.

NOTES: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD,
AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE

DURING TRANSPORTATION.

	COUNT	DESCRIPTION OF REVISIONS DESIGNED			CHECKED			ATE	
Δ	1		MI.SAKIMURA		HK. UMEHAR		10.	05. 24	
Unless otherwise specified, refer to JIS C 5402.				APPROVI	ED	KJ. KATAYOSE	05.	05.01.05	
				CHECKE	D	TY. OMA	05.	01.05	
				DESIGNE	ĒD	TS. KUMAZAWA	05.01.05		
				DRAWN	1	TS. KUMAZAWA	05. 01. 05		
Note	QT:Qua	lification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	NO. ELC4-162343-10				
HS.		SPECIFICATION SHEET	PART NO.	DF1-*P-2. 5DS (05))			
		HIROSE ELECTRIC CO., LTD.	CODE NO.	CL541		541	Δ	1/1	